



Advanced laser solutions for interconnect and component production.

ProVia Laser Drilling and RapiTrim Laser Trim and Test Systems

PPI Systems provides a broad range of turn-key solutions to the interconnect and electronic component market for via drilling, circuit processing, trim and test, and high-precision micro-machining.



Blind Via Drilling • Through Hole Via Drilling • Resistor Trimming •
Buried Via Drilling • Cutting • Routing • Patterning • Skiving
• Embedded Circuits • Defect Repair



Advanced laser solutions for interconnect and component production.

ProVia Laser Drilling Systems

ProVia FP-UC Dual-laser Hybrid (UV & CO₂) System

Total process capability in copper clad laminates

ProVia FP-C Single-laser (CO₂) System

Dielectric and thin copper processing

ProVia FP-U Single-laser (UV) System

Superior drilling and cutting quality in copper and dielectrics



RapiTrim Laser Test and Trim Systems

RapiTrim Laser Trim and Test Systems

Large format system for full-size PCBs

RapiTrim-C Laser Trim and Test Systems

Hybrid circuit trim and test



ProSys System Software

An intuitive graphical user interface that offers unmatched ease of use for both operators and process engineers. All machine setup and calibration controls, job and process settings, vision and process map, status and diagnostic information are accessible with a single click or tap.

